



GP
ELECTRONICS

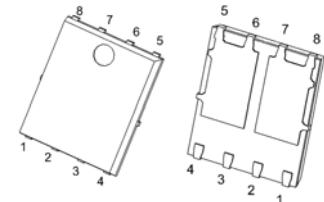
GPM270NP03LNC

30V N- and P-Channel MOSFET

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
30V	19mΩ@10V	18A
	28mΩ@4.5V	
-30V	27mΩ@-10V	-12A
	35mΩ@-4.5V	

PDFN5X6-8L



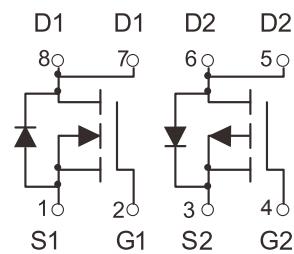
Feature

- Trench Technology Power MOSFET
- Low $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

Application

- Power Switching Application

Schematic diagram



MARKING:



M270NP03L = Device Code

XX = Date Code

Solid Dot = Green Indicator

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Value	Unit
Drain - Source Voltage	V_{DS}	30	-30	V
Gate - Source Voltage	V_{GS}	± 20	± 20	V
Continuous Drain Current ¹	I_D	18	-12	A
	I_D	12	-8	A
Pulsed Drain Current ²	I_{DM}	72	-48	A
Single Pulsed Avalanche Current ³	I_{AS}	10	-13.5	A
Single Pulsed Avalanche Energy ³	E_{AS}	25	46	mJ
Power Dissipation ⁵	P_D	17	15	W
Thermal Resistance from Junction to Ambient ⁶	$R_{\theta JA}$	50	50	$^\circ\text{C}/\text{W}$
Thermal Resistance from Junction to Case	$R_{\theta JC}$	7.4	8.3	$^\circ\text{C}/\text{W}$
Junction Temperature	T_J	150	150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55~+150	-55~+150	$^\circ\text{C}$

MOSFET ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ C$ unless otherwise noted)
NMOS:

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain - Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 30V, V_{GS} = 0V$			1	μA
Gate - Body Leakage Current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 100	nA
On Characteristics⁴						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.8	3.0	V
Drain-source On-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 5A$		19	33	$m\Omega$
		$V_{GS} = 4.5V, I_D = 5A$		28	48	
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 15V, V_{GS} = 0V, f = 1MHz$		521		pF
Output Capacitance	C_{oss}			66		
Reverse Transfer Capacitance	C_{rss}			49		
Gate Resistance	R_g	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$		2.4		Ω
Switching Characteristics						
Total Gate Charge	Q_g	$V_{DS} = 15V, V_{GS} = 10V, I_D = 2A$		11		nC
Gate-source Charge	Q_{gs}			1.6		
Gate-drain Charge	Q_{gd}			2.2		
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 15V, V_{GS} = 10V, I_D = 9A, R_G = 6\Omega$		5		ns
Turn-on Rise Time	t_r			3		
Turn-off Delay Time	$t_{d(off)}$			15		
Turn-off Fall Time	t_f			4		
Source - Drain Diode Characteristics						
Diode Forward Voltage ⁴	V_{SD}	$V_{GS} = 0V, I_S = 1A$			1.2	V

MOSFET ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)
PMOS:

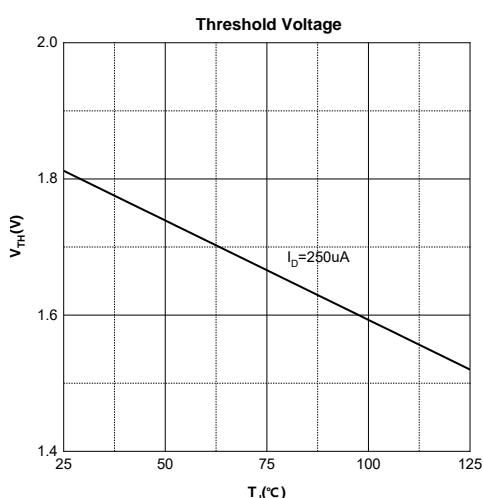
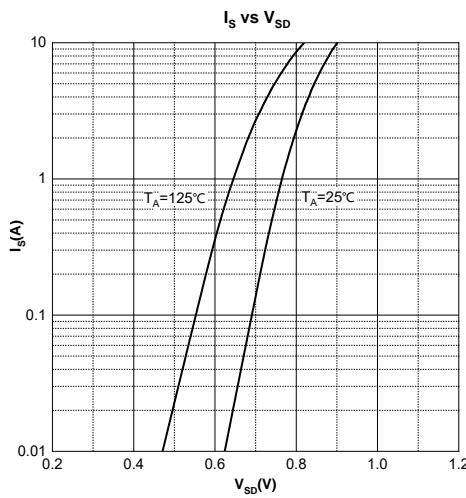
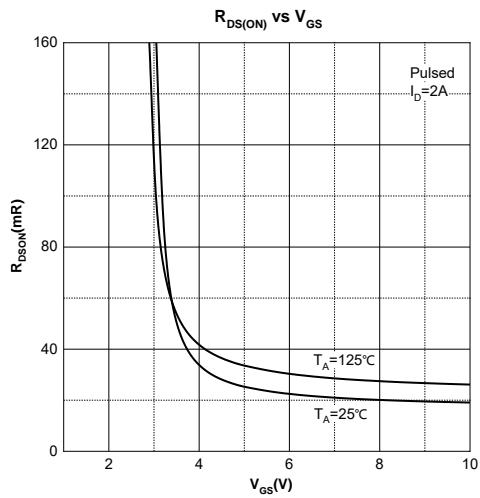
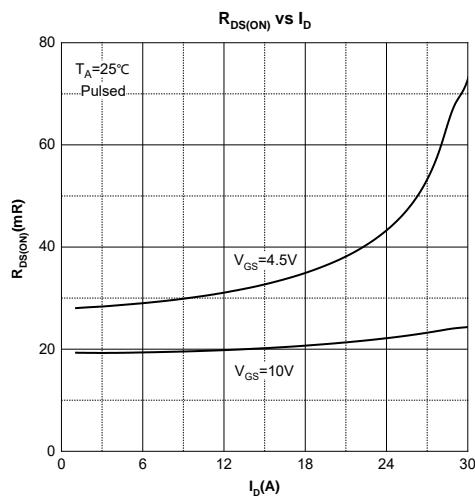
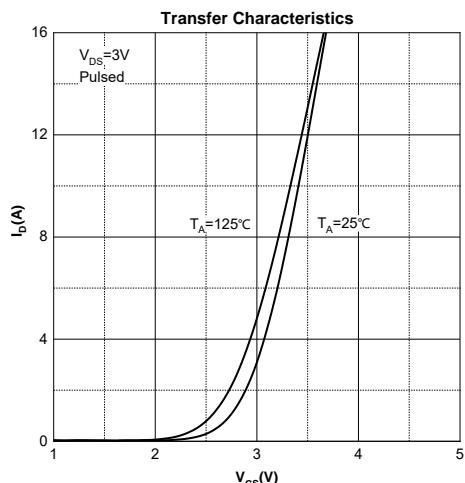
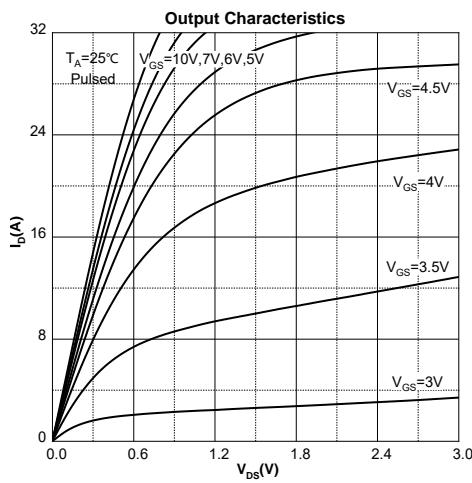
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Gate - Body Leakage Current	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			± 100	nA
On Characteristics⁴						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-1.0	-1.4	-2.5	V
Drain-source On-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, I_D = -5\text{A}$		27	46	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_D = -5\text{A}$		35	70	
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		1019		pF
Output Capacitance	C_{oss}			110		
Reverse Transfer Capacitance	C_{rss}			97		
Gate Resistance	R_g	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		20		Ω
Switching Characteristics						
Total Gate Charge	Q_g	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = -10\text{V}, I_D = -2\text{A}$		22		nC
Gate-source Charge	Q_{gs}			2.3		
Gate-drain Charge	Q_{gd}			4.1		
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -15\text{V}, V_{\text{GS}} = -10\text{V}, I_D = -6\text{A}, R_G = 3\Omega$		8		ns
Turn-on Rise Time	t_r			6		
Turn-off Delay Time	$t_{\text{d}(\text{off})}$			19		
Turn-off Fall Time	t_f			7		
Source - Drain Diode Characteristics						
Diode Forward Voltage ⁴	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_s = -1\text{A}$			-1.2	V

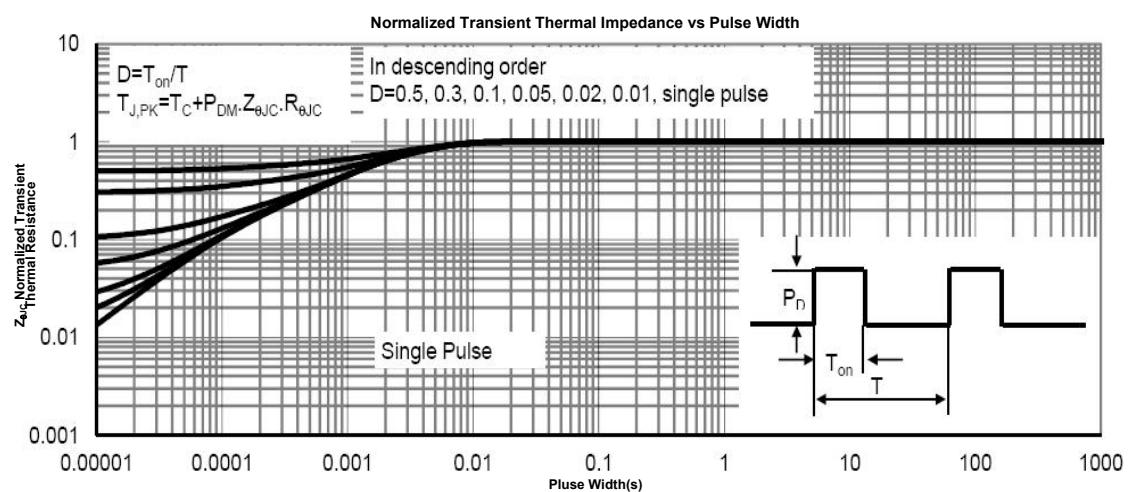
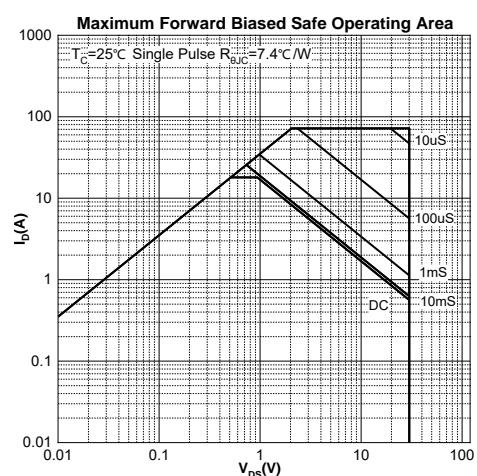
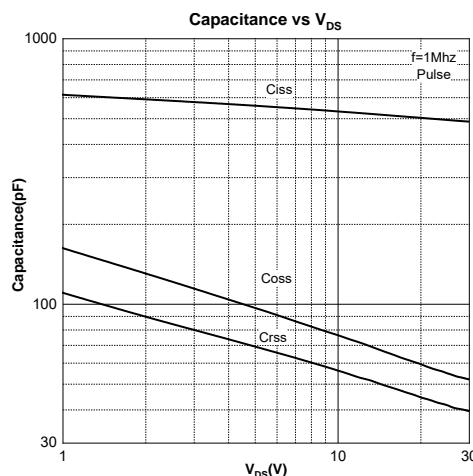
Notes :

- 1.The maximum current rating is limited by package.And device mounted on a large heatsink
- 2.Pulse Test : Pulse Width $\leq 10\mu\text{s}$, duty cycle $\leq 1\%$.
- 3.E_{AS} condition: $V_{\text{DD}} = \pm 15\text{V}, V_{\text{GS}} = \pm 10\text{V}, L = 0.5\text{mH}, R_G = 25\Omega$ Starting $T_J = 25^\circ\text{C}$.
- 4.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- 5.The power dissipation P_D is limited by $T_{J(\text{MAX})} = 150^\circ\text{C}$.And device mounted on a large heatsink
- 6.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

Typical Characteristics

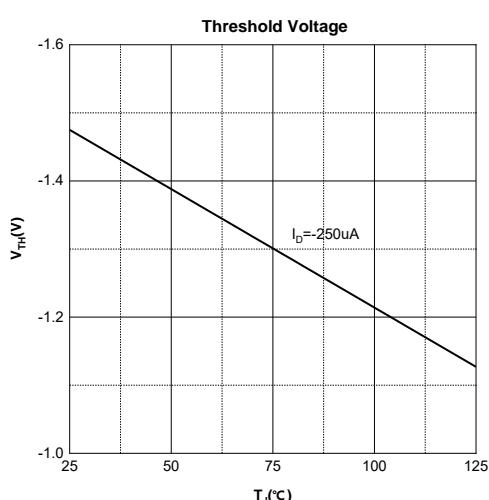
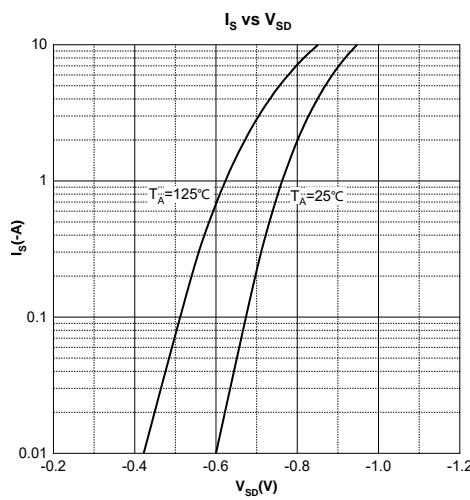
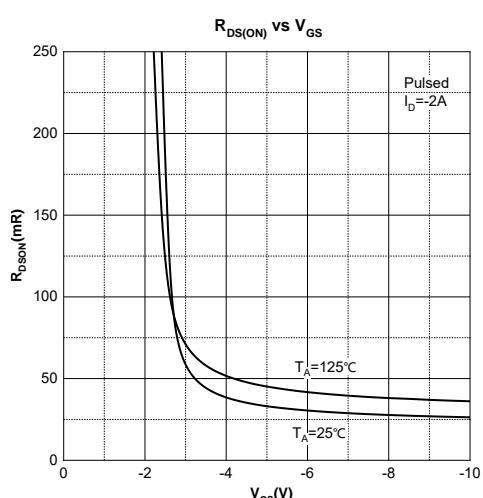
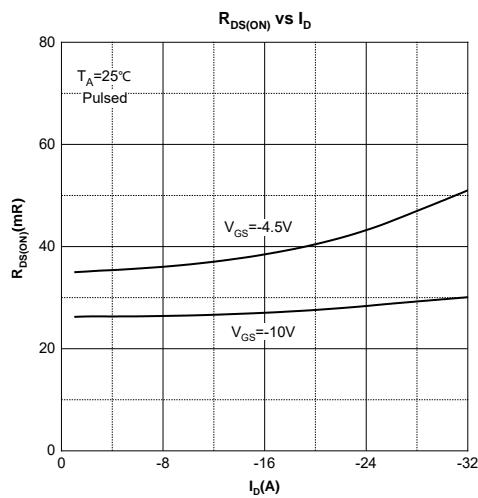
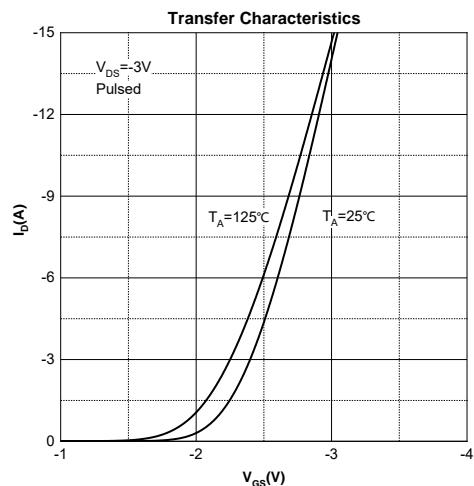
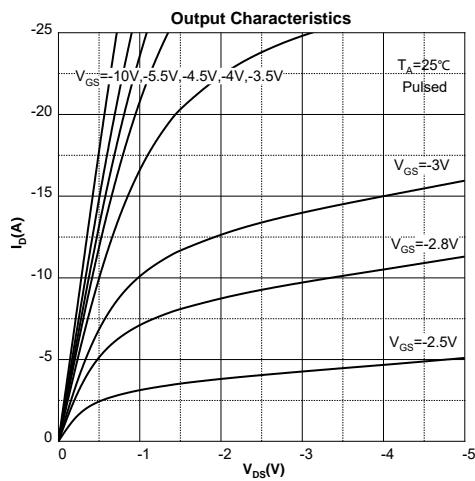
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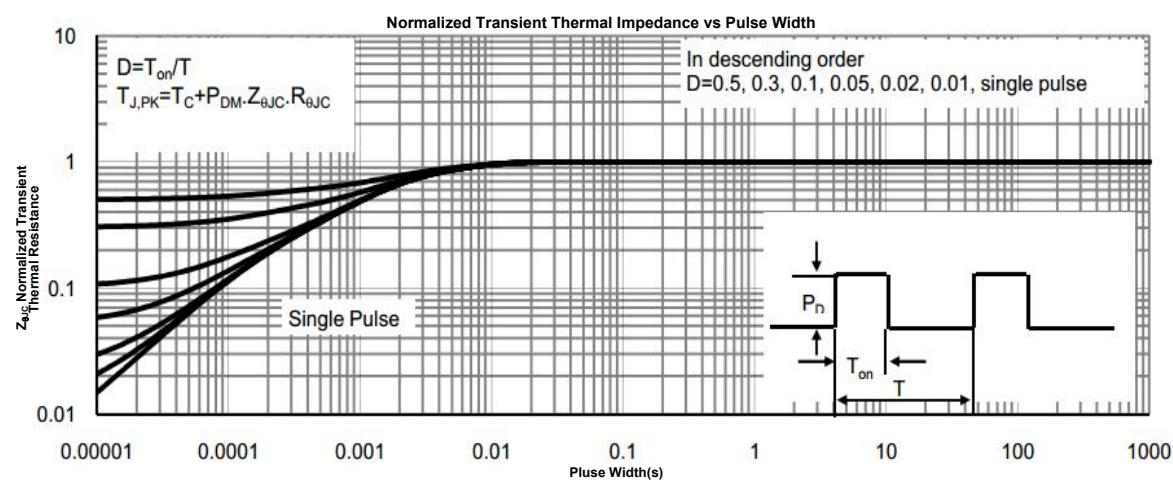
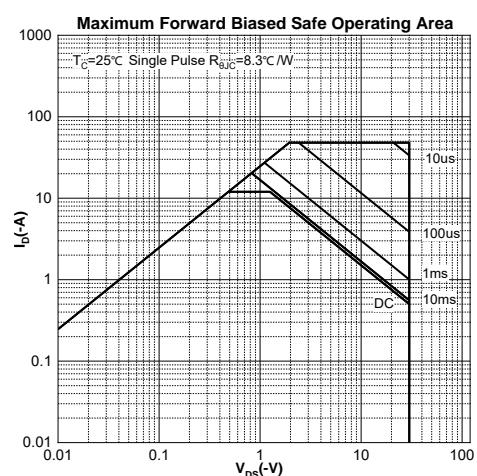
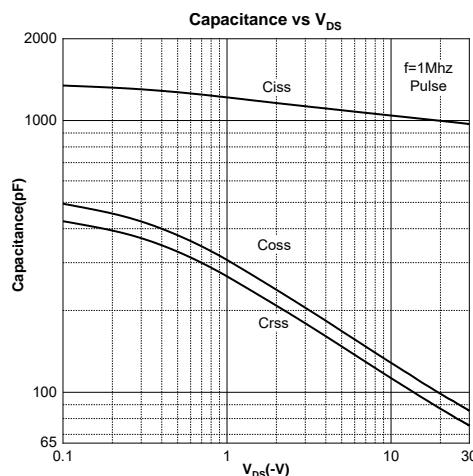


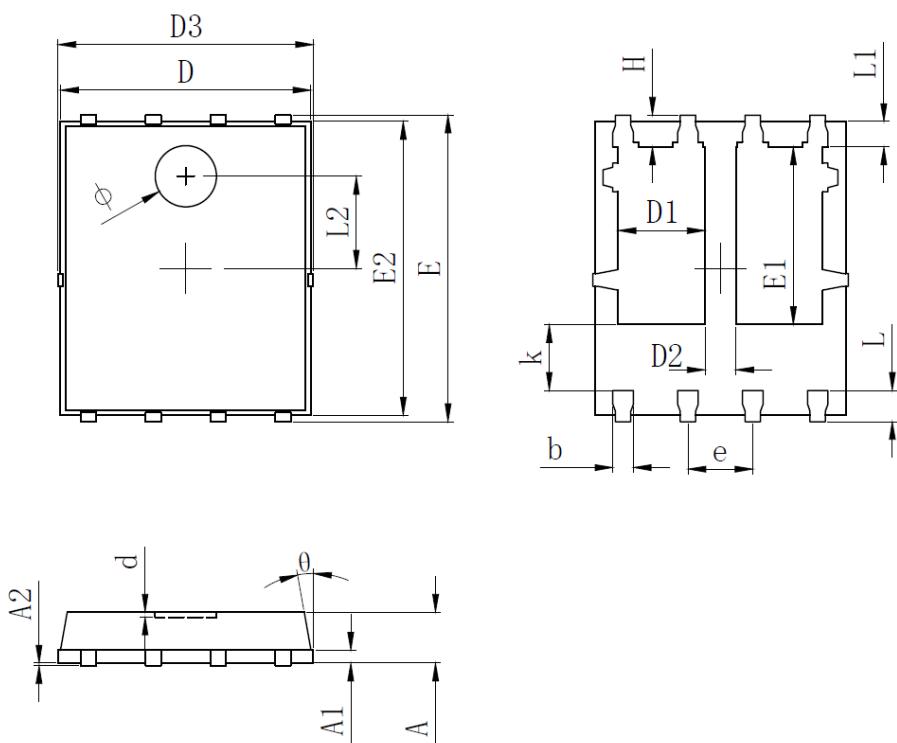


Typical Characteristics

PMOS:





PDFN5X6-8L Package Information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.100	0.035	0.043
A1	0.254REF		0.010REF	
A2	0.000	0.050	0.000	0.002
D	4.824	4.976	0.190	0.196
D1	1.605	1.805	0.063	0.071
D2	0.500	0.700	0.020	0.028
D3	4.924	5.076	0.194	0.200
E	5.924	6.076	0.233	0.239
E1	3.375	3.575	0.133	0.141
E2	5.674	5.826	0.223	0.229
b	0.350	0.450	0.014	0.018
e	1.270TYP		0.050TYP	
L	0.534	0.686	0.021	0.027
L1	0.424	0.576	0.017	0.023
L2	1.800REF		0.071REF	
k	1.190	1.390	0.047	0.055
H	0.549	0.701	0.022	0.028
θ	8°	12°	8°	12°
Φ	1.100	1.300	0.043	0.051
d	-	0.100	-	0.004